

THW

I hereby certify that this correspondence is being deposited with the United States Postal Service, with sufficient postage, as first class mail in an envelope addressed to:

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450
on April 17, 2006

Date of Deposit

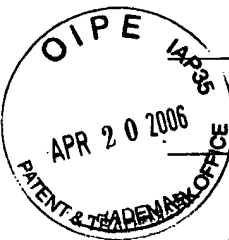
Jasper W. Dockrey, Reg. No. 33,868

Name of applicant, assignee or
Registered Representative

Jasper W. Dockrey
Signature

April 17, 2006

Date of Signature



Our Case No. 10808/121

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: SUNG, Kwon O.

Serial No.: 10/751,257

Filing Date: April 17, 2006

For: METHOD OF MANUFACTURING A
LAYER SEQUENCE AND A
METHOD OF MANUFACTURING
AN INTEGRATED CIRCUIT

)
)
)
) Examiner: E.B. Chen
)
) Group Art Unit No.: 1765
)
)
)

AMENDMENT AND RESPONSE UNDER 37 C.F.R. § 1.111

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

In response to the Office Action of November 15, 2005, in the above-referenced application, please reconsider the rejection in view of the amendment and remarks presented herein.

Amendment of the claims appears in the listing of claims that begins at page 2 of this paper. Applicants' remarks begin at page 6 of this paper.